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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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BIPOLAR ANALOG INTEGRATED CIRCUIT μ PC8116GR

500 MHz, AM/ASK RECEIVER IC

DESCRIPTION

The μ PC8116GR is a Silicon monolithic IC designed for AM/ASK receiver. This IC consists of mixer, oscillator, IF amplifier, Limitter amplifier, OP Amp., and builts in power save function and RSSI function.

The 20-pin plastic SSOP package is suitable for high-density surface mounting.

This IC is manufactured using NEC's 20 GHz fr NESAT[™]III silicon bipolar process. This process uses direct silicon nitride passivation film and gold electrodes. These materials can protect the chip surface from pollution and prevent corrosion/migration. Thus, this IC realizes excellent performance, uniformity and reliability.

: Icc = 4.1 mA TYP.@Vcc = VPs = 3.0 V

: ICCPS = 1 μ A MAX. @Vcc = 3.0 V, PS = 0 V

: 20-pin plastic SSOP (6.7 × 4.4 × 1.5 mm)

: Vcc = 2.7 to 5.5 V

: fref = 100 to 500 MHz

FEATURES

- Supply voltage
- Low current consumption
- Wideband response
- Power save function
- · High-density surface mounting

ORDERING INFORMATION

 Part Number
 Package
 Supplying Form

 μPC8116GR-E1
 20-pin plastic SSOP (5.72 mm (225))
 Embossed tape 12 mm wide.

 Pin 1 is in tape pull-out direction.
 QTY 2.5 kpcs/reel.

Remark To order evaluation samples, please contact your local NEC sales office. (Part number for sample order: μ PC8116GR)

Caution Electro-static sensitive devices

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PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Conditions	Ratings	Unit
Supply Voltage	Vcc	$T_A = +25^{\circ}C$	6.0	V
Power Dissipation	PD	Mounted on double-sided copper clad $50 \times 50 \times 1.6$ mm epoxy glass PWB at T_A = +85°C	430	mW
Operating Ambient Temperature	TA		–40 to +85	°C
Storage Temperature	Tstg		–55 to +150	°C

RECOMMENDED OPERATING RANGE

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc	2.7	3.0	5.5	V
Operating Ambient Temperature	TA	_40	+25	+85	°C

ELECTRICAL CHARACTERISTICS (Unless otherwise specified, TA = +25°C, Vcc = VP/s = 3 V)

Parameter	Symbol	Test Conditions		MIN.	TYP.	MAX.	Unit
Total Block							
Circuit Current	lcc	no signals	Note 1	2.6	4.1	5.7	mA
RSSI Sensitivity	RSSIsen	$f_{RF} = 315 \text{ MHz}, \text{ fosc} = 304.3 \text{ MHz}, $ -10 dBm, $\Delta V_{RSST} \ge 3 \text{ mV/dB}$	Posc = Note 1	_	-95	-90	dBm
Powersave Current	Ips	17 pin = GND	Note 1	-	1	1.0	μA
Mixer Block							
RF Input Band Width	BWrf	$f_{\text{IF}} = 10.7 \text{ MHz}, \text{ f}_{\text{RF}} > \text{f}_{\text{OSC}}, -3 \text{ dB} \text{ det}$	own Note 2	100	-	500	MHz
LO Input Band Width	BWLO	$f_{\text{IF}} = 10.7 \text{ MHz}, \text{ f}_{\text{RF}} > \text{f}_{\text{OSC}}, -3 \text{ dB} \text{ d}_{\text{OSC}}$	own Note 2	100	Ι	500	MHz
Mixer Gain	Gмix	$f_{RF} = 315 \text{ MHz}, P_{RF} = -50 \text{ dBm}, \text{ fo}$ 304.3MHz, $P_{osc} = -10 \text{ dBm}, \text{ Input:}$ matching	sc = :LC Note 1	8	11	14	dB
IF Amp. Block							
IF Output Band Width	BWIF	P _{in} = -80 dBm, -3dB down	Note 2	0.3	-	15	MHz
OP Amp. Block							
OP Amp. Band Width	BWOP	$P_{in} = -50 \text{ dBm}, -3\text{dB} \text{ down}$	Note 2	1	_	-	MHz
OP Amp. Gain	Gop	$f_{in} = 200 \text{ kHz}, P_{in} = -50 \text{ dBm}$	Note 2	50	57	-	dB

Notes 1. By test circuit 1

2. By test circuit 2

STANDARD CHARACTERISTICS (Unless otherwise specified, TA = +25°C, Vcc = VP/s = 3.0 V)

Parameter	Symbol	Test conditions		Value for reference	Unit
IF Amplifier Gain	GIF	$f_{\text{in}} = 10.7 \text{ MHz}, P_{\text{in}} = -100 \text{ dBm}, \text{ Inp} \text{ Matching}$	out:LC Note	55	dB
RSSI Linearity	$\Delta RSSI/$ ΔP_{RF}	$f_{RF} = 315 \text{ MHz}, \text{ fosc} = 304.3 \text{ MHz}, \text{ F}$ = -10 dBm, $P_{RF} = -30 \text{ to } -90 \text{ dBm}$	Posc Note	±3	dB
LO to RF Isolation	LO-RFISL	fosc = 304.3 MHz/-10 dBm	Note	-50	dBm
RF to LO Isolation	RF-LOISL	frf = 315 MHz/-30 dBm	Note	-50	dBm
Note By test circuit 1					

PIN EXPLANATION

Pin No.	Pin Name	Pin Voltage (V)	Function and Application	Internal Equivalent Circuit
1	RFin	1.95	Input pin of RF Mixer.	
2	MIXout	2.1	Output pin of Mixer. This pin is assigned for emitter follower output with Low-impedance.	
3	IF Ampin	2.38	Input pin of IF Amplifier.	
4	BYPASS⁺	2.38	Bypass pin for IF Amplifier. Capacitor for filter should be connected between 4 pin and 5 pin.	
5	BYPASS ⁻	2.38		(4)
6	RSSIout	0.9	RSSI signal output pin.	
7	Vcc	0	Supply voltage pin.	(15)
8	GND	5	Ground pin of OP Amp Block.	
9	OP Amp ⁺	2.1	Input pin of OP Amp. In case of single input, 9 pin or 10 pin should be grounded through capacitor.	
10	OP Amp ⁻	2.1		

Pin No.	Pin Name	Pin Voltage (V)	Function and Application	Internal Equivalent Circuit
11	OP Amp _{out}	0.77	Output pin of OP Amp.	
12	BYPASS ⁻	2.38	Bypass pin for OP Amp. Capacitor for filter should be connected between 12 pin and 13 pin.	
13	BYPASS⁺	2.38		
14	LIMin	2.38	Input pin of Limitter Amplifier.	
15	GND	-	Ground pin of Limitter Amp., RSSI, and regulator.	15
16	IFout	1.55	IF signal output pin. Generally, Crystal filter is connected between 16 pin and 14 pin.	
17	Power Save	0 to 3.0	Power save control pin can be controlled ON/SLEEP state with bias as follows; VP/s (V) STATE Vcc ON GND SLEEP	
18	OSC-E	1.31	Oscillator signal input pins. Oscillator circuit should be connected between 18 pin and 19 pin.	
19	OSC-C	3.0		
20	GND	_	Ground pin of Mixer, IF Amplifier, and Oscillator.	



TYPICAL CHARACTERISTICS (Unless otherwise specified, T_A = +25°C, Vcc = 3.0 V)

STANDARD CHARACTERISTICS (Unless otherwise specified, TA = +25°C)



Remark The graphs indicate nominal characteristics.

TEST CIRCUIT1





2. 17 pin: GND, 11 pin: OPEN in case of measurement of powersave current



TEST CIRCUIT2

Remark Measured by High-impedance Probe (1 MHz, 1.5pF)

APPLICATION CIRCUIT EXAMPLE (@fr = 433.6 MHz)



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

Data Sheet P12361EJ3V0DS00

ILLUSTRATION OF THE APPLICATION CIRCUIT ASSEMBLED ON EVALUATION BOARD



- Notes
 - *1) Backside is GND pattern
 - *2) O shows through holes
 *3) E pattern should be removed on this application
 - *4) shows short circuited strip for ground

PACKAGE DIMENSIONS

20 PIN PLASTIC SSOP (5.72 mm (225)) (UNIT: mm)



NOTE Each lead centerline is located within 0.10 mm of its true position (T.P.) at maximum material condition.

NOTE ON CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as wide as possible to minimize ground impedance (to prevent abnormal oscillation).
- (3) Keep the track length of the ground pins as short as possible.
- (4) Connect a bypass capacitor (example: 1 000 pF) to the Vcc pin.
- (5) Frequency signal input/output pins must be each coupled with capacitor for DC cut.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your NEC sales representative.

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared Reflow	Package peak temperature: 235°C or below Time: 30 seconds or less (at 210°C) Count: 3, Exposure limit: None ^{Nete}	IR35-00-3
VPS	Package peak temperature: 215°C or below Time: 40 seconds or less (at 200°C) Count: 3, Exposure limit: None ^{Nete}	VP15-00-3
Wave Soldering	Soldering bath temperature: 260°C or below Time: 10 seconds or less Count: 1, Exposure limit: None ^{Nete}	WS60-00-1
Partial Heating	Pin temperature: 300°C Time: 3 seconds or less (per side of device) Exposure limit: None ^{Note}	_

Note After opening the dry pack, keep it in a place below 25°C and 65% RH for the allowable storage period.

Caution Do not use different soldering methods together (except for partial heating).

For details of recommended soldering conditions for surface mounting, refer to information document SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL (C10535E).



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 - Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
 - Specific: Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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